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Vishay Siliconix

Automotive P-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	-40				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.014				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.023				
I _D (A)	-17.3				
Configuration	Single				

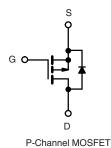
FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE



ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free and halogen-free	SQ4401CEY (for detailed order number please see www.vishay.com/doc?79771)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-40	V
Gate-source voltage		V _{GS}	± 20	V
Continuous drain current	T _C = 25 °C	- I _D	-17.3	
	T _C = 125 °C		-10	
Continuous source current (diode conduction)		Is	-6.5	Α
Pulsed drain current ^a		I _{DM}	-69	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-30	
Single pulse avalanche energy	L = U. I IIII	E _{AS}	45	mJ
Maximum power dissipation	T _C = 25 °C	В	7.14	W
	T _C = 125 °C	P_{D}	2.4	VV
Operating junction and storage temperature	e range	T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount b	R _{thJA}	85	°C/W		
Junction-to-foot (drain)		R_{thJF}	21	C/VV		

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. When mounted on 1" square PCB (FR-4 material)



Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static						ı		
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0, I _D = -250 μA		-40	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-1.5	-2.0	-2.5	V	
Gate-source leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	±100	nA	
		V _{GS} = 0 V	V _{DS} = -40 V	-	-	-1.0		
Zero gate voltage drain current	I _{DSS}	V _{GS} = 0 V	V _{DS} = -40 V, T _J = 125 °C	-	-	-50	μA	
		V _{GS} = 0 V	V _{DS} = -40 V, T _J = 175 °C	-	-	-150		
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	V _{DS} ≥ -5 V	-30	_	-	Α	
		V _{GS} = -10 V	I _D = -10.5 A	-	0.011	0.014		
		V _{GS} = -10 V	I _D = -10.5 A, T _J = 125 °C	-	-	0.020	Ω	
Drain-source on-state resistance a	R _{DS(on)}		I _D = -10.5 A, T _J = 175 °C	-	-	0.024		
		V _{GS} = -4.5 V	I _D = -8.7 A	-	0.018	0.023		
Forward transconductance a	9 _{fs}		-15 V, I _D = -10.5 A	-	30	_	S	
Dynamic ^b	313	1 50	. , , ,			L		
Input capacitance	C _{iss}			_	3471	4250		
Output capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = -20 V, f = 1 MHz	-	526	580	pF	
Reverse transfer capacitance	C _{rss}	1	,	-	349	436		
Total gate charge ^c	Qg			-	71	115		
Gate-source charge ^c	Q _{gs}	$V_{GS} = -10 \text{ V}$	$V_{DS} = -20 \text{ V}, I_{D} = -10.5 \text{ A}$	-	11.4	_	nC	
Gate-drain charge c	Q _{qd}	1 33	50 7 5	-	18.3	_		
Gate resistance	R _g		f = 1 MHz		1.90	3.21	Ω	
Turn-on delay time ^c	t _{d(on)}			_	35	85		
Rise time ^c	t _r	1 ,	- 15 V D - 15 O	-	52	105	1	
Turn-off delay time c	t _{d(off)}	V_{DD} = -15 V, R_L = 15 Ω $I_D \cong$ -1 A, V_{GEN} = -4.5 V, R_g = 6 Ω		_	62	85	ns	
Fall time ^c	t _f			_	50	55		
Source-Drain Diode Ratings and Chara	·				00			
Pulsed current ^a	I _{SM}			_	_	-69	Α	
Forward voltage	V _{SD}	I _F =	-2.7 A, V _{GS} = 0 V	-	-0.75	-1.1	V	
Body diode reverse recovery time	t _{rr}	I _F = -2.1 A, di/dt = 100 A/μs		-	30	60	ns	
Body diode reverse recovery charge	Q _{rr}			-	36	72	nC	
Reverse recovery fall time	t _a			-	19	-	ns	
Reverse recovery rise time	t _b			-	11	-		
Body diode peak reverse recovery curren	t I _{RM(REC)}		-	-2.5	-	Α		

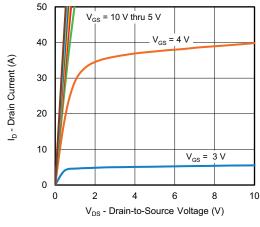
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

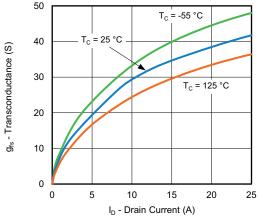
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



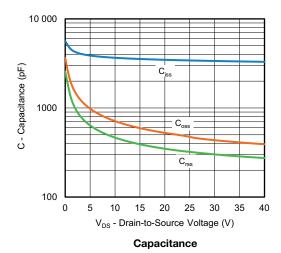
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

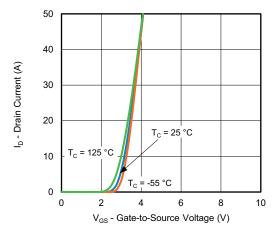


Output Characteristics

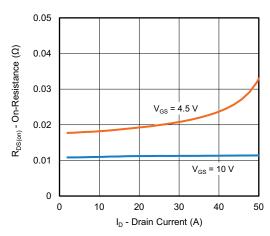


Transconductance

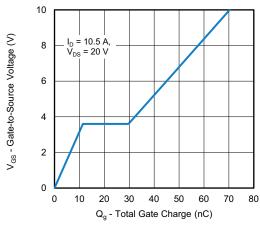




Transfer Characteristics



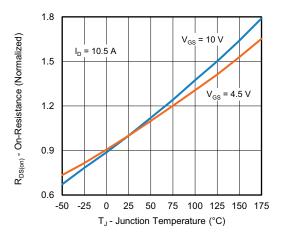
On-Resistance vs. Drain Current



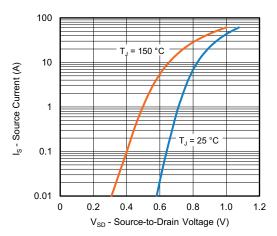
Gate Charge



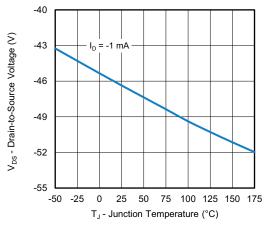
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



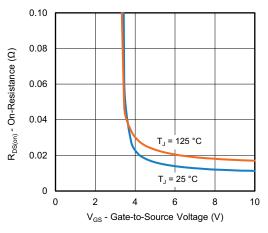
On-Resistance vs. Junction Temperature



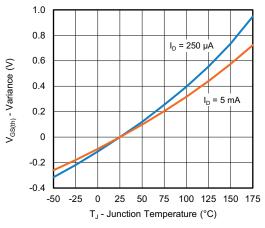
Source Drain Diode Forward Voltage



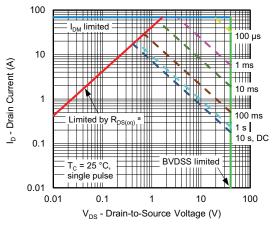
Breakdown Voltage vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Safe Operating Area

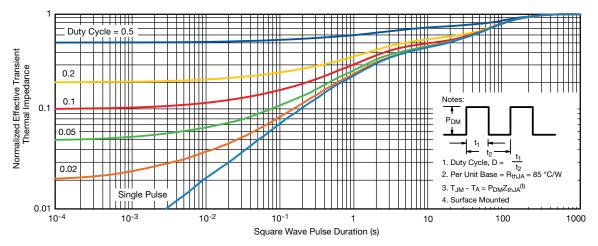
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

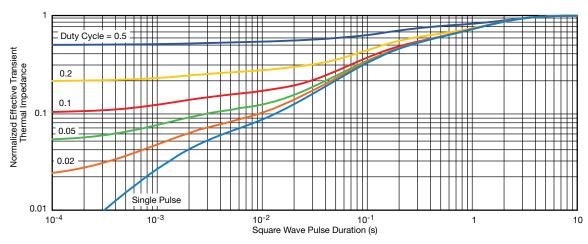
For technical questions, contact: automostech



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)
- are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single
 pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part
 mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities
 can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62016.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050) BSC	
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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